

MOS FIELD EFFECT TRANSISTOR μ PA1707

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

FEATURES

· Low on-resistance

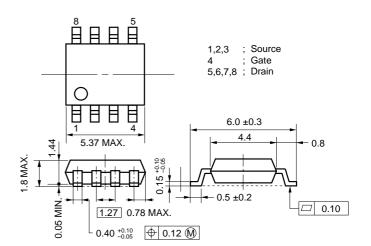
$$\begin{split} &R_{DS(on)1} = 10.0 \text{ m}\Omega \text{ (TYP.) (VGS} = 10 \text{ V, ID} = 5.0 \text{ A)} \\ &R_{DS(on)2} = 12.5 \text{ m}\Omega \text{ (TYP.) (VGS} = 4.5 \text{ V, ID} = 5.0 \text{ A)} \\ &R_{DS(on)3} = 14.0 \text{ m}\Omega \text{ (TYP.) (VGS} = 4.0 \text{ V, ID} = 5.0 \text{ A)} \end{split}$$

- Low Ciss: Ciss = 1400 pF (TYP.)
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1707G	Power SOP8

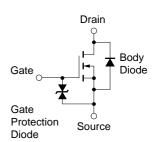
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	Voss	30	V	
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V	
Drain Current (DC)	ID(DC)	±10	Α	
Drain Current (pulse) Note1	D(pulse)	±40	Α	
Total Power Dissipation (T _A = 25° C) Note2	Рт	2.0	W	
Channel Temperature	Tch	150	°C	
Storage Temperature	Tstg	-55 to +150	°C	

EQUIVALENT CIRCUIT



- **Notes 1.** PW \leq 10 μ s, Duty Cycle \leq 1 %
 - 2. Mounted on ceramic substrate of 1200 mm² x 1.7 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

The information in this document is subject to change without notice.



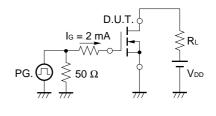
ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 5.0 A		10.0	13.5	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 5.0 A		12.5	18	mΩ
	RDS(on)3	Vgs = 4.0 V, ID = 5.0 A		14.0	21	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 5.0 A	5.0	13		S
Drain Leakage Current	Ipss	V _{DS} = 30 V, V _{GS} = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V		1400		pF
Output Capacitance	Coss	Vgs = 0 V		450		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		180		pF
Turn-on Delay Time	td(on)	ID = 5.0 A		20		ns
Rise Time	tr	VGS(on) = 10 V		185		ns
Turn-off Delay Time	td(off)	V _{DD} = 15 V		65		ns
Fall Time	t f	$R_G = 10 \Omega$		40		ns
Total Gate Charge	Q _G	ID = 10 A		26		nC
Gate to Source Charge	Qgs	V _{DD} = 24 V		4.2		nC
Gate to Drain Charge	Q _{GD}	Vgs = 10 V		6.5		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 10 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 10 A, VGS = 0 V		30		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		25		nC

TEST CIRCUIT 1 SWITCHING TIME

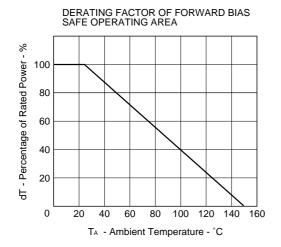
PG. $\bigcap_{RG} R_G = 10 \ \Omega$ $V_{GS} \bigvee_{Wave Form} 0 \stackrel{10 \%}{\longrightarrow} V_{GS(on)} \stackrel{90 \%}{\longrightarrow} V_{GS(on)} \stackrel{90 \%}{\longrightarrow} V_{GS(on)} \stackrel{10 \%}{\longrightarrow} V_{G$

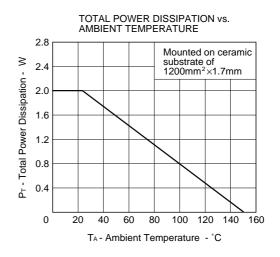
TEST CIRCUIT 2 GATE CHARGE





TYPICAL CHARACTERISTICS (TA = 25 °C)

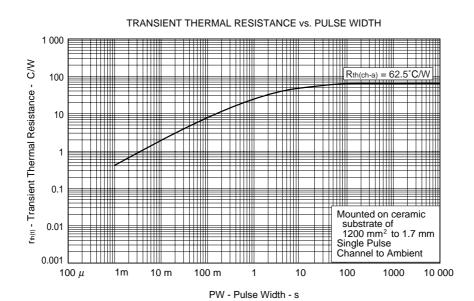




FORWARD BIAS SAFE OPERATING AREA 100 100 Tc = 25 °C Single Pulse 0.1 10 10 Vos - Drain to Source Voltage - V

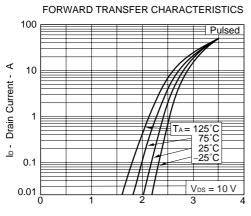
Note

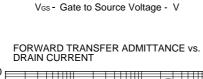
Mounted on ceramic substrate of $1200\,\text{mm}^2\times1.7\,\text{mm}$

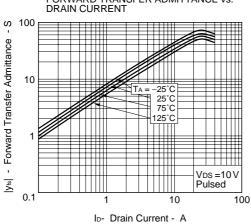


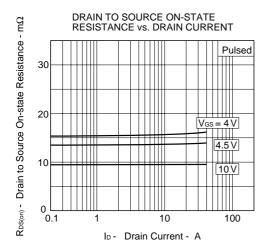
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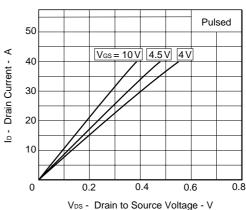




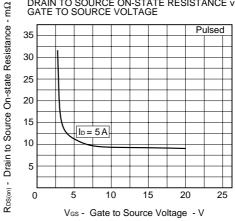




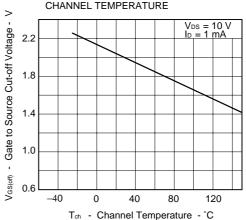
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

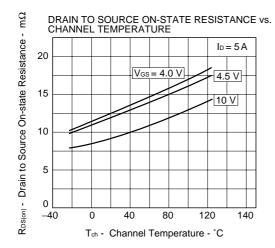


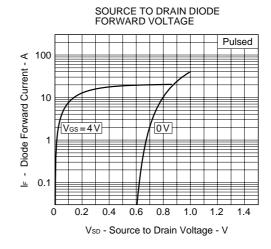
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

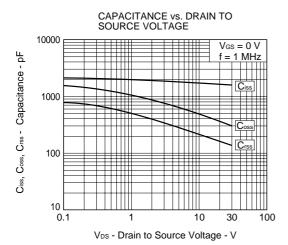


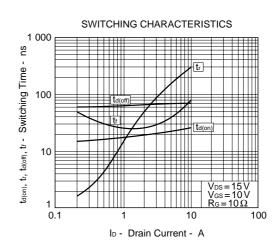
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

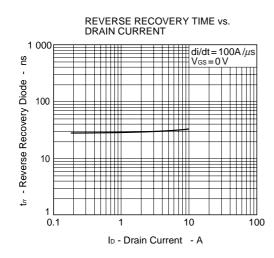


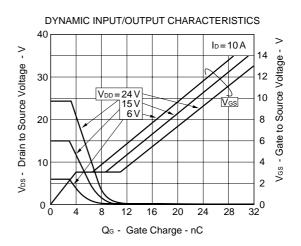












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Anti-radioactive design is not implemented in this product.

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